

4N65-Q

Power MOSFET

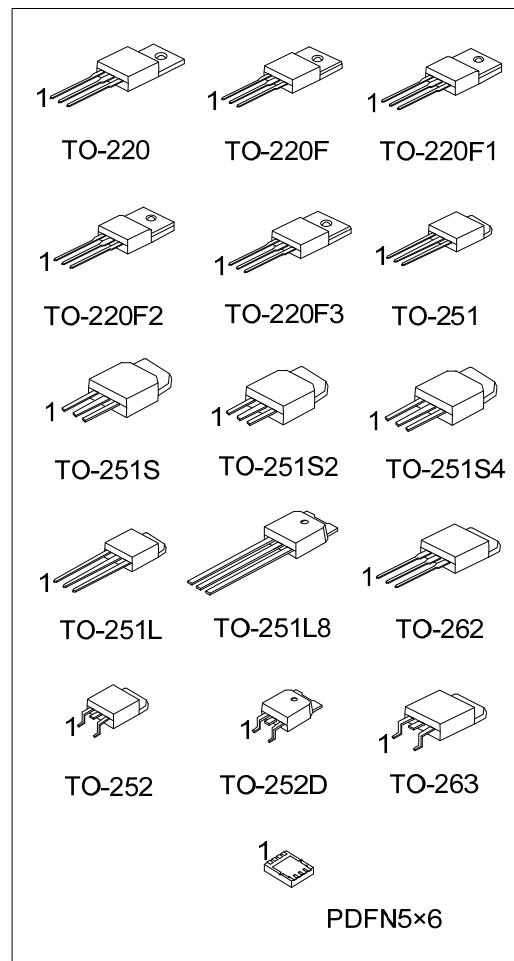
4.0A, 650V N-CHANNEL POWER MOSFET

■ DESCRIPTION

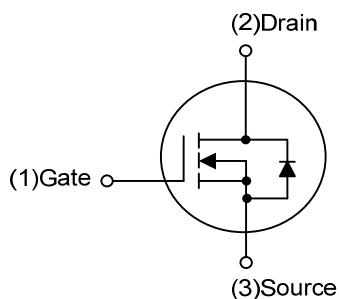
The UTC 4N65-Q is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristic. This power MOSFET is usually used in high speed switching applications including power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

■ FEATURES

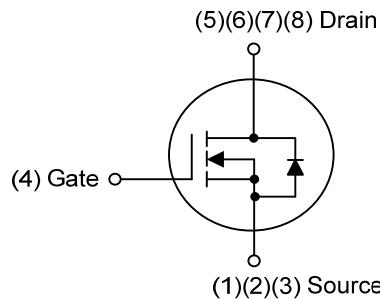
- * $R_{DS(ON)} \leq 3.1 \Omega$ @ $V_{GS}=10V$, $I_D=2.2A$
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness



■ SYMBOL



TO-220/TO-220F/TO-220F1
TO-220F2/TO-220F3/TO-251
TO-251S/TO-251L/TO-251L8
TO-251S2/TO-251S4/TO-252
TO-252D/TO-262/TO-263



PDFN5x6

■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
4N65L-TA3-T	4N65G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
4N65L-TF1-T	4N65G-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
4N65L-TF2-T	4N65G-TF2-T	TO-220F2	G	D	S	-	-	-	-	-	Tube
4N65L-TF3T-T	4N65G-TF3T-T	TO-220F3	G	D	S	-	-	-	-	-	Tube
4N65L-TF3-T	4N65G-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
4N65L-TM3-T	4N65G-TM3-T	TO-251	G	D	S	-	-	-	-	-	Tube
4N65L-TMA-T	4N65G-TMA-T	TO-251L	G	D	S	-	-	-	-	-	Tube
4N65L-TMA8-T	4N65G-TMA8-T	TO-251L8	G	D	S	-	-	-	-	-	Tube
4N65L-TMS-T	4N65G-TMS-T	TO-251S	G	D	S	-	-	-	-	-	Tube
4N65L-TMS2-T	4N65G-TMS2-T	TO-251S2	G	D	S	-	-	-	-	-	Tube
4N65L-TMS4-T	4N65G-TMS4-T	TO-251S4	G	D	S	-	-	-	-	-	Tube
4N65L-TN3-R	4N65G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
4N65L-TND-R	4N65G-TND-R	TO-252D	G	D	S	-	-	-	-	-	Tape Reel
4N65L-T2Q-T	4N65G-T2Q-T	TO-262	G	D	S	-	-	-	-	-	Tube
4N65L-TQ2-R	4N65G-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
4N65L-TQ2-T	4N65G-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
4N65L-P5060-R	4N65G-P5060-R	PDFN5×6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, TF3T: TO-220F3, TM3: TO-251, TMA: TO-251L, TMA8: TO-251L8, TMS: TO-251S, TMS2: TO-251S2, TN3: TO-252, TMS4: TO-251S4, TND: TO-252D, T2Q: TO-262, TQ2: TO-263, P5060: PDFN5×6 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING

PACKAGE		MARKING	
TO-220	TO-251S		
TO-220F	TO-251S2		
TO-220F1	TO-251S4		
TO-220F2	TO-252		
TO-220F3	TO-252D		
TO-251	TO-262		
TO-251L	TO-263		
TO-251L8			
PDFN5×6			

■ ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	± 30	V
Avalanche Current (Note2)		I_{AR}	4.4	A
Drain Current	Continuous	I_D	4.0	A
	Pulsed (Note2)	I_{DM}	16	A
Avalanche Energy	Single Pulsed (Note3)	E_{AS}	60	mJ
	Repetitive (Note2)	E_{AR}	10.6	mJ
Peak Diode Recovery dv/dt (Note4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220/TO-262/TO-263	P_D	106	W
	TO-220F/TO-220F1		36	W
	TO-220F3		38	W
	TO-220F2		50	W
	TO-251/TO-251L		30	W
	TO-251L8/TO-251S			
Junction Temperature		T_J	+150	°C
Operating Temperature		T_{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 30\text{mH}$, $I_{AS} = 2.1\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\ \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 4.4\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-262/TO-263 TO-220F/TO-220F1 TO-220F2/TO-220F3	θ_{JA}	62.5	°C/W
	TO-251/TO-251L TO-251L8/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		83	°C/W
	PDFN5x6		75 (Note)	°C/W
Junction to Case	TO-220/TO-262/TO-263	θ_{JC}	1.18	°C/W
	TO-220F/TO-220F1		3.47	°C/W
	TP-220F3		3.28	°C/W
	TO-220F2		2.5	°C/W
	TO-251/TO-251L TO-251L8/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		4.17 (Note)	°C/W
	PDFN5x6			

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

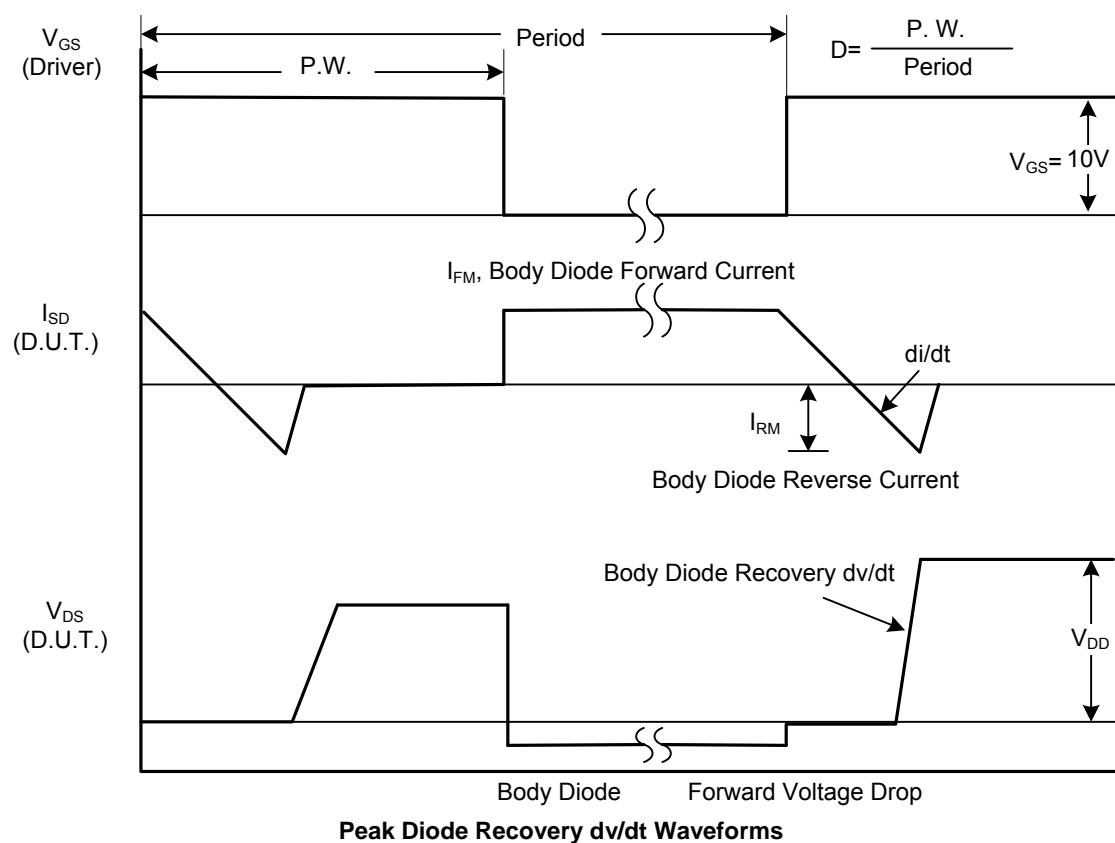
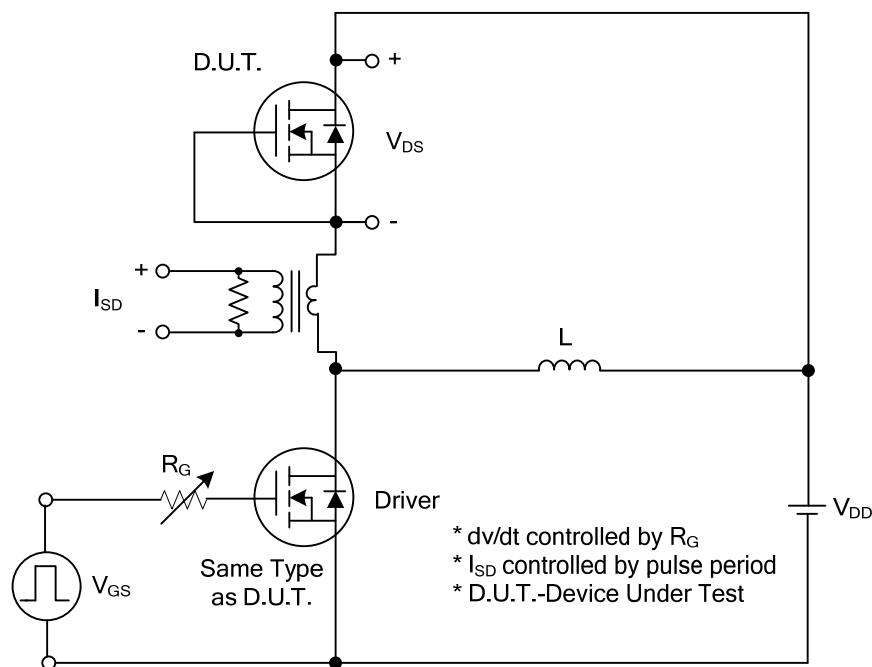
■ ELECTRICAL CHARACTERISTICS ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}} = 0 \text{ V}, \text{I}_D = 250\mu\text{A}$	650			V
Drain-Source Leakage Current	I_{DSS}	$\text{V}_{\text{DS}} = 650 \text{ V}, \text{V}_{\text{GS}} = 0 \text{ V}$			10	μA
Gate-Source Leakage Current	Forward	$\text{V}_{\text{GS}} = 30 \text{ V}, \text{V}_{\text{DS}} = 0 \text{ V}$			100	nA
	Reverse	$\text{V}_{\text{GS}} = -30 \text{ V}, \text{V}_{\text{DS}} = 0 \text{ V}$			-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta\text{BV}_{\text{DSS}}/\Delta T_J$	$\text{I}_D=250\mu\text{A}$, Referenced to 25°C		0.6		$\text{V}/^\circ\text{C}$
ON CHARACTERISTICS						
Gate Threshold Voltage	$\text{V}_{\text{GS(TH)}}$	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}} = 10 \text{ V}, \text{I}_D = 2.2\text{A}$		2.9	3.1	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$\text{V}_{\text{GS}}=\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$		470	530	pF
Output Capacitance	C_{OSS}			50	70	pF
Reverse Transfer Capacitance	C_{RSS}			10	13	pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q_G	$\text{V}_{\text{DS}}=520\text{V}, \text{I}_D= 4.0\text{A}, \text{V}_{\text{GS}}=10\text{V}$ (Note 1, 2)		55	75	nC
Gate-Source Charge	Q_{GS}			15	21	nC
Gate-Drain Charge	Q_{GD}			18	24	nC
Turn-On Delay Time (Note 1)	$t_{\text{D(ON)}}$	$\text{V}_{\text{DS}}=325\text{V}, \text{I}_D 4.0\text{A}, \text{R}_G=25\Omega$ (Note 1, 2)		38	75	ns
Turn-On Rise Time	t_R			45	85	ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			90	130	ns
Turn-Off Fall Time	t_F			35	80	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Continuous Drain-Source Diode Forward Current	I_S				4.4	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				17.6	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	$\text{V}_{\text{GS}} = 0 \text{ V}, \text{I}_S = 4.4\text{A}$			1.4	V
Reverse Recovery Time (Note 1)	t_{rr}	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_S = 4.4\text{A},$ $d\text{I}_F/dt = 100 \text{ A}/\mu\text{s}$ (Note 1)		250		ns
Reverse Recovery Charge	Q_{rr}			1.5		μC

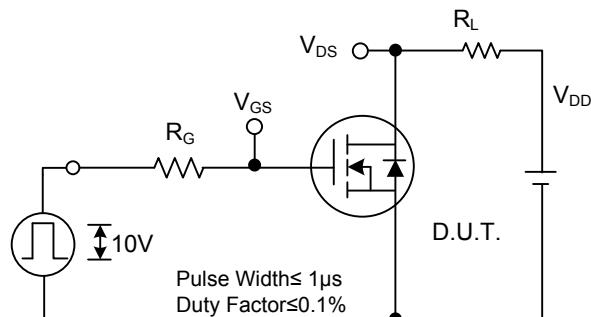
Note: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

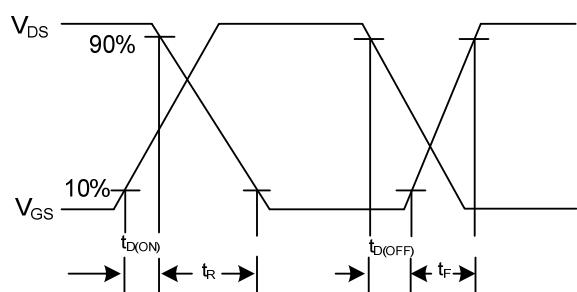
■ TEST CIRCUITS AND WAVEFORMS



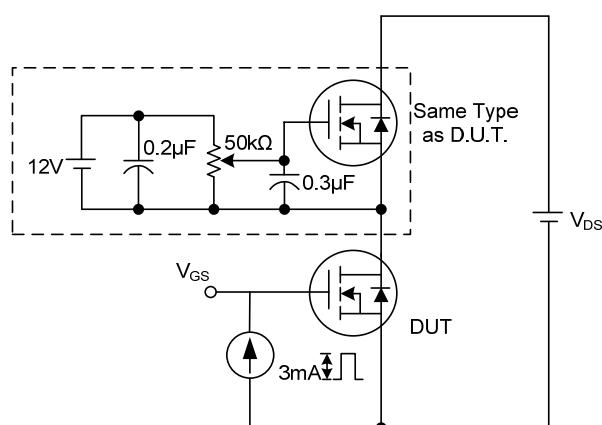
■ TEST CIRCUITS AND WAVEFORMS



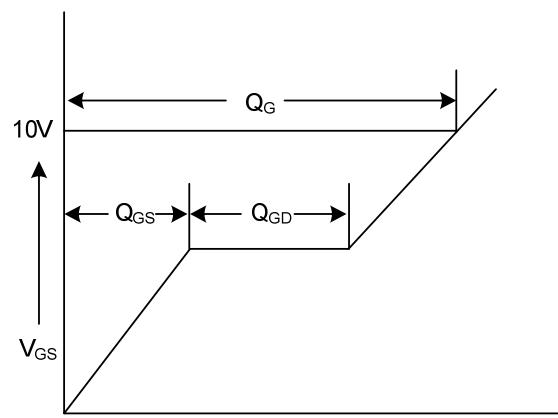
Switching Test Circuit



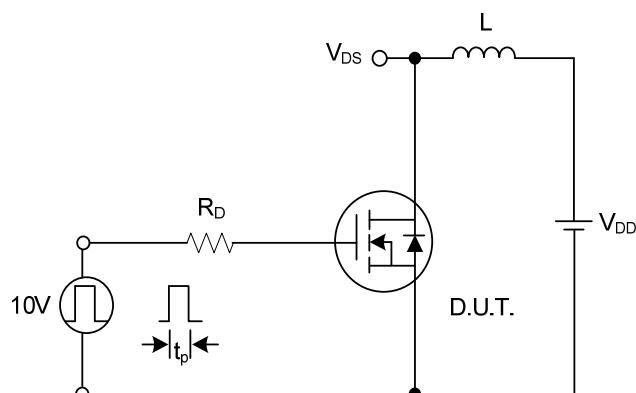
Switching Waveforms



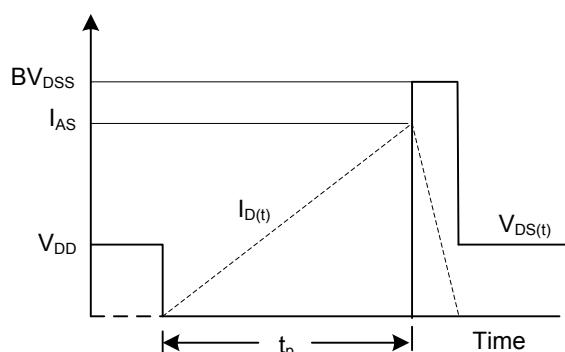
Gate Charge Test Circuit



Gate Charge Waveform

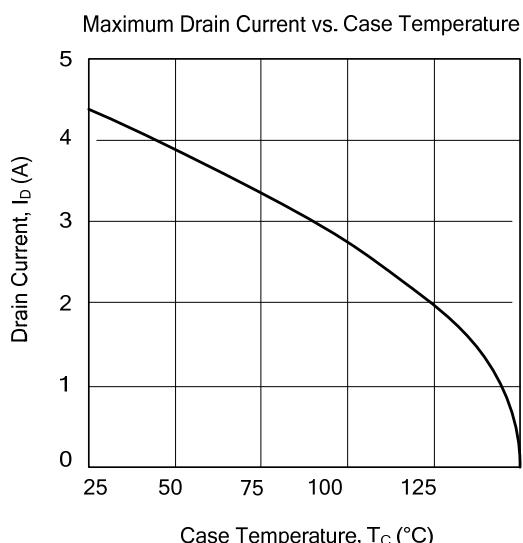
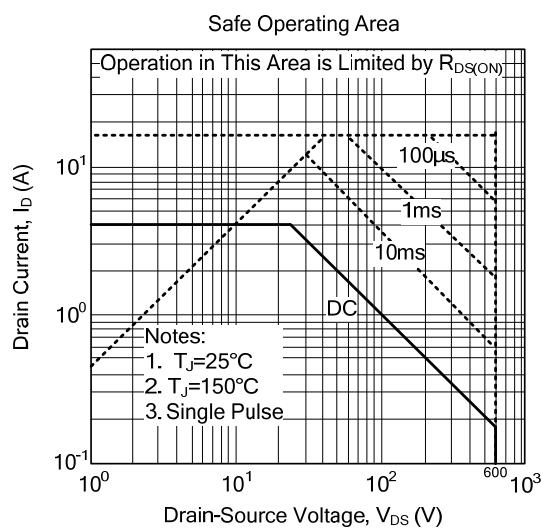
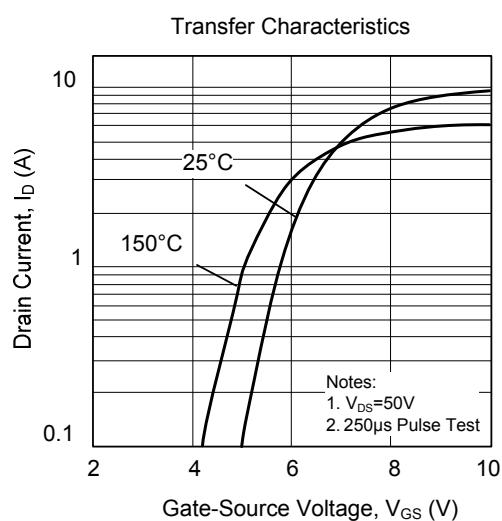
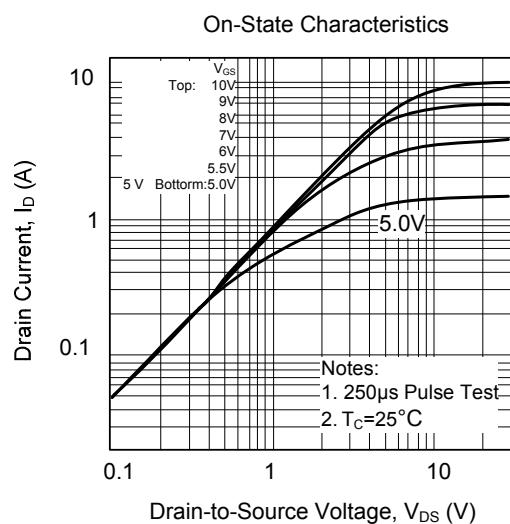
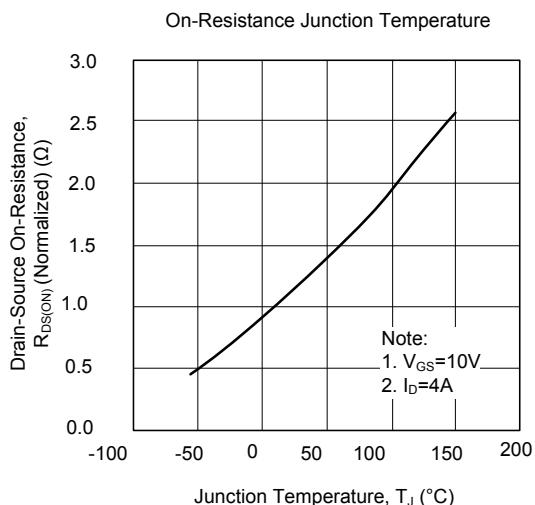
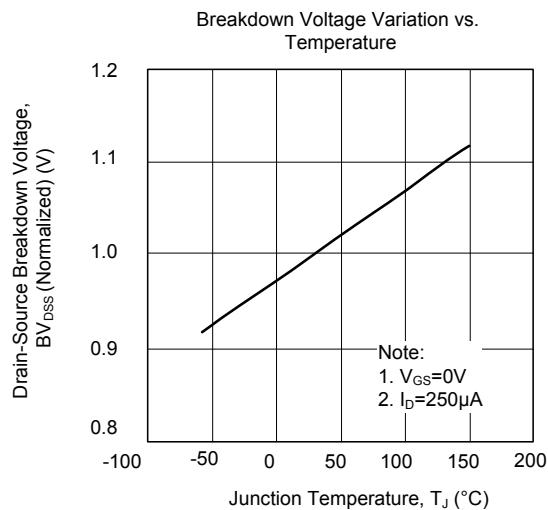


Unclamped Inductive Switching Test Circuit

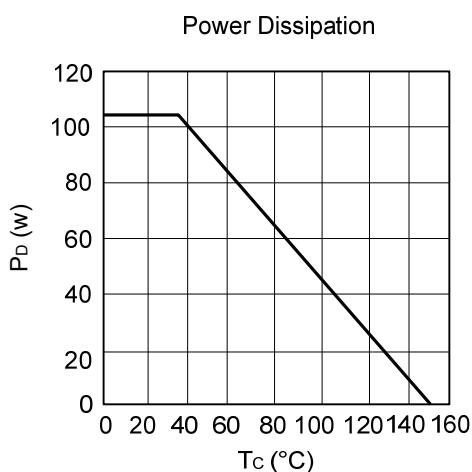
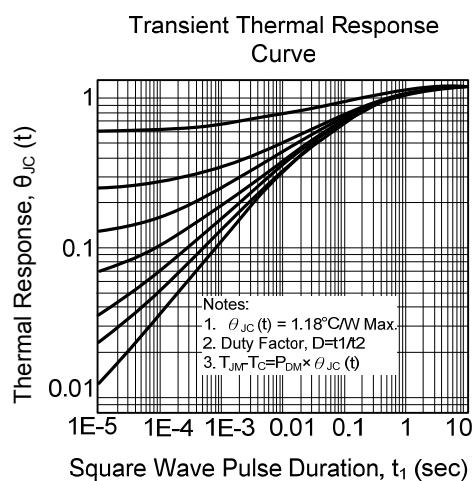
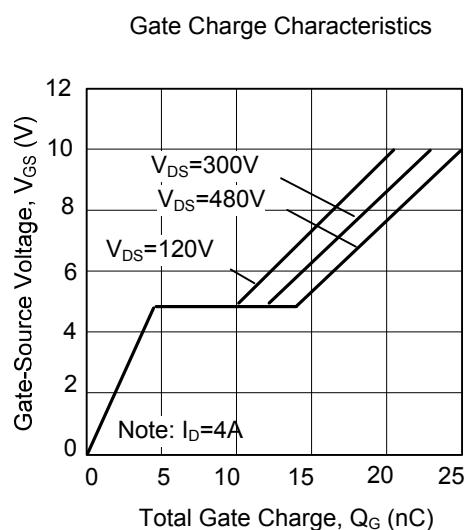
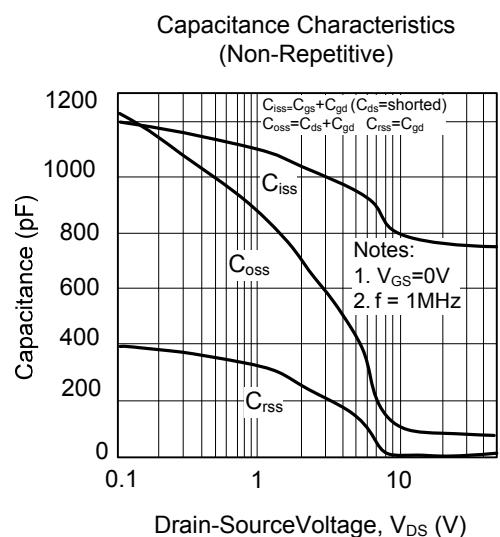
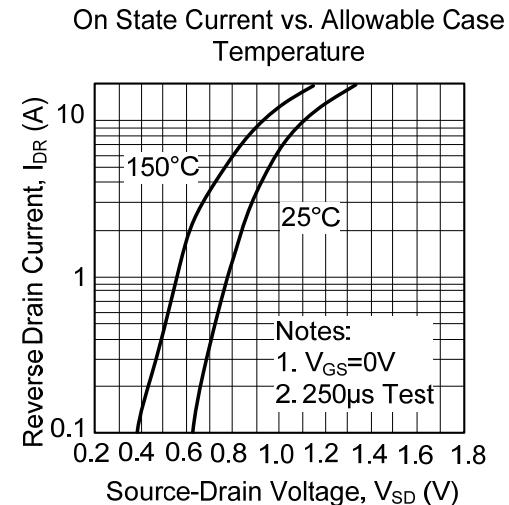
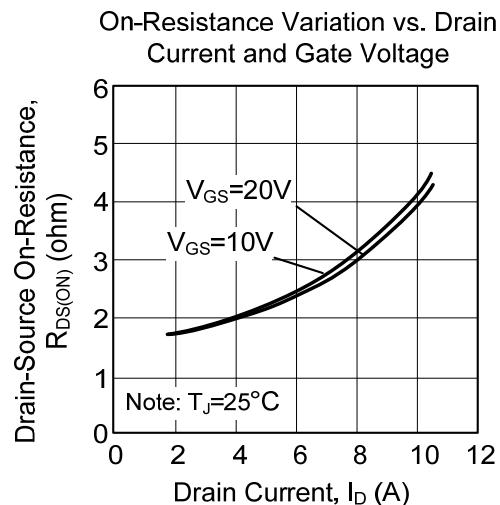


Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



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